

Form PTO-1595

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1. Name of conveying party(ies): KAWASHIMA, YOSHIYUKI ITO, FUMITOSHI SAKAI, TAKESHI ISHII, YASUSHI	2. Name and address of receiving party(ies) Name: RENESAS TECHNOLOGY CORP.	
KANAMARU, YASUHIRO HASHIMOTO, TAKASHI MIZUNO, MAKOTO OKUYAMA, KOUSUKE Additional name(s) of conveying party(ies) attached? Yes No 3. Nature of conveyance:	Street Address: 4-1, Marunouchi 2-chome, Chiyoda- ku, Tokyo, Japan	
	Additional name(s) & address(es) attached? ☐ Yes ☒ No	
Execution Date: Feb. 23, 2004; Mar. 9, 2004; Feb. 23, 23, 23, 23, 24, 23, 2004.	3/30/04	
 Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: Feb. 23, 2004; Mar. 9. 		
2004; Feb. 23, 23, 23, 24, 23, 2004. A. Patent Application No.(s)	B. Patent Registration No.(s)	
Additional number(s) atta	 	
Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved 1	
Name: Antonelli, Terry, Stout & Kraus, LLP	7. Total fee (37 CFR 3.41)\$40.00 ☑ Enclosed	
Internal Address:	☐ Authorized to be charged to deposit account	
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9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Gregory E. Montone. Reg# 28.141 Name of Person Signing Signature Date		
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PATENT REEL: 015163 FRAME: 0115

ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Renesas Technology Corp., a corporation organized under the laws of Japan,

located at 4-1, Marunouchi 2-chome, Chiyoda-ku, Tokyo, Japan,

receipt of which is hereby acknowledged I do hereby sell and assign to said Renesas Technology Corp., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

A SEMICONDUCTOR DEVICE AND A METHOD OF MANUFACTURING THE SAME

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said Renesas Technology Corp.,

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Renesas Technology Corp.,

Signed on the date(s) indicated aside our signatures:

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Date Signed (署名日)

1) Yoshiyuki Kawashima	Yoshiyuki KAWASHIMA	23/February/2004
2) Funitadii Ito	Fumitoshi ITO	91 March 1 2004
3) Takeshy Sakai	Takeshi SAKAI	23/February/2004
4) Yasushi Ishii	Yasushi ISHII	23/ February / 2004
5) Yasuhiro KANAMARU	Yasuhiro KANAMARU	23/ February /2004
6) Takashi Hashimoto	Takashi HASHIMOTO	23/ February /2004
7) Makoto Mizuno	Makoto MIZUNO	24/February/2004
8) Kouraka Obsayama	Kousuke OKUYAMA	23/ Fobruary / 2004
9)		
10)		

PATENT REEL: 015163 FRAME: 0116

RECORDED: 03/30/2004